

Microstructural Evolution of Sintering Ceramic Films

Dustin Frame

IGERT MCCE

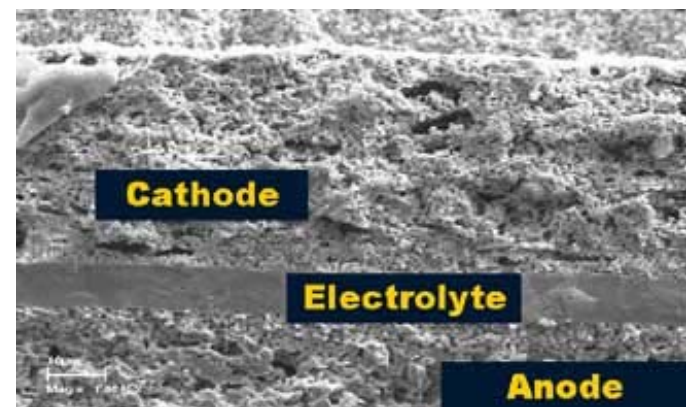
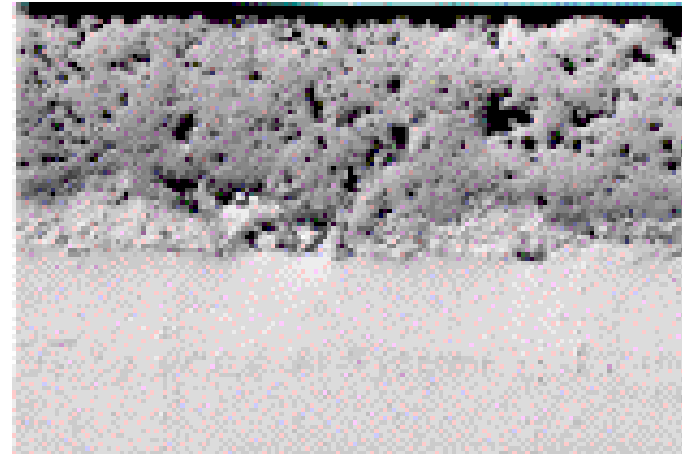
Materials Science & Engineering, and

Nanotechnology PhD candidate

March 7th, 2006

Goal: to understand the effect of an external force on the microstructure development of a sintering ceramic.

A better understanding will allow us to design ceramic materials with better properties (electronic, strength, etc.).



THE CENTER FOR
NANOTECHNOLOGY

UNIVERSITY OF
WASHINGTON

Microstructural Evolution of Sintering Ceramic Films

Artificially introduce defects into green ceramics before sintering.
-Controlled sized pores
-Controlled sized cracks/holes

Make film
(like clay)



Introduce defects



Stress film &
Sinter at
same time

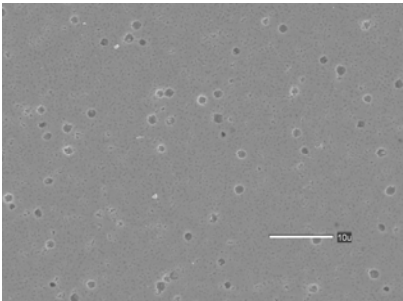


Study
microstructure
development

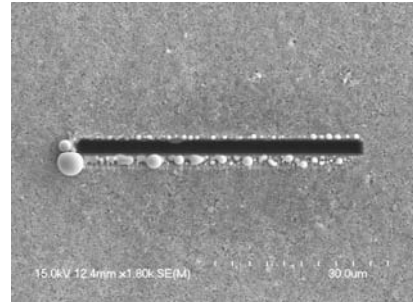
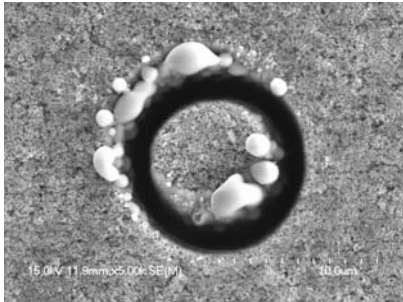
Polystyrene
spheres introduced
pore defects



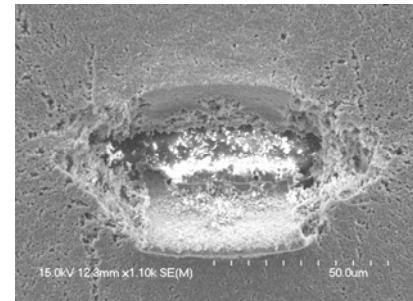
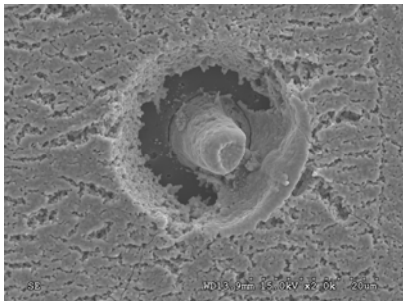
Heating/Sintering



Focus Ion Beam
(FIB) introduced
defects



Heating/Sintering

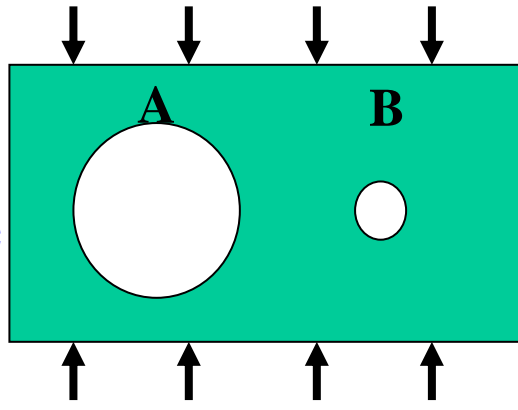


(top and bottom not same scale)



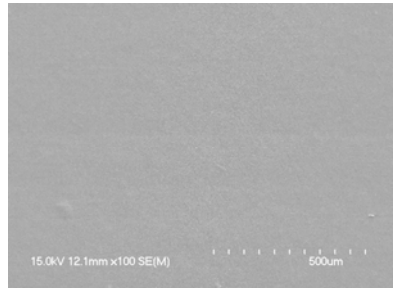
Microstructural Evolution of Sintering Ceramic Films

Pore Analysis Conclusions:
-Stressed ceramics develop anisotropic microstructures
-Transition point defines anisotropic behavior

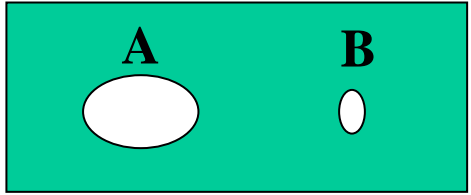
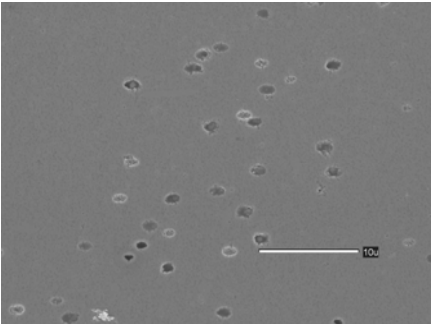


Before Sintering

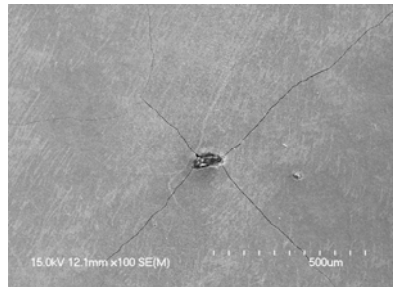
FIB Analysis Conclusions:
-Stress concentration has large effect on crack development and propagation
-Short-Long crack transition point determined



Without defect



After Sintering



With defect

- New methods to study these complex systems have been developed.
- These methods have increase the understanding of microstructure behavior.
- This knowledge will increase the ability to design these materials with better electronic or strength properties.

